

UNITED STATES PATENT APPLICATION  
FOR

## KICKER FOR NON-VOLATILE MEMORY DRAIN BIAS

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# **DRAIN BIAS FOR NON-VOLATILE MEMORY**

## **FIELD OF THE INVENTION**

This invention relates to computer memory in general, and more specifically to  
5 providing a kicker function for non-volatile memory drain bias.

## **BACKGROUND OF THE INVENTION**

Non-volatile memory that can retain information when a power supply is  
switched off, such as flash memory, is being used increasingly in electronic devices for  
personal and commercial use, including cellular telephones, digital cameras, embedded  
10 devices, and personal data assistants. Flash memory is well suited for such uses because  
it is electrically erasable and can be reprogrammed within normal circuit parameters,  
without requiring special programming devices operating at higher than normal voltage  
levels.

Technology has made it possible to produce flash memory that is increasingly  
15 dense, resulting in greater and greater amounts of memory being available to electronic  
products. However, increasing the density of memory results in increased power  
consumption. Further, in order to reduce the power consumption of these products, there  
has also been an attempt to operate flash memory at lower voltages and to utilize low  
power circuits, which presents additional challenges to keep up with performance  
20 demand and cost restraints.

Flash memory is composed of flash cells that require a certain drain voltage for  
proper operation. The function of a drain bias circuit is to provide the necessary drain  
voltage to a flash cell. The load in a drain bias converts the current differential between



there are 128 drain bias circuits, resulting in significant current drain and physical space requirements. As the physical area for drain bias circuits increases, the parasitic capacitance created generally will also increase, and this capacitance creates power losses in the memory device.

- 5           In addition to non-volatile memory moving towards larger scale devices, the device supply voltages levels have also been reduced to save power in operation and extend the life of power sources. As non-volatile memory moves to these lower supply voltages, it becomes more difficult to bring voltages up to necessary operating levels quickly so as not to sacrifice speed of memory operation.

## BRIEF DESCRIPTION OF THE DRAWINGS

The appended claims set forth the features of the invention with particularity. The invention, together with its advantages, may be best understood from the following detailed description taken in conjunction with the accompanying drawings of which:

5           Figure 1 is a block diagram illustrating an embodiment of a non-volatile memory sensing apparatus;

            Figure 2 is an illustration of a typical drain bias circuit for non-volatile memory including a biasing feedback inverter;

            Figure 3 is an illustration of a static cascode drain bias circuit;

10           Figure 4 illustrates a sample and hold reference generator;

            Figure 5 illustrates a drain bias current mirror and column load with a sample and hold reference source;

            Figure 6 illustrates a drain bias kicker circuit; and

            Figure 7 contains a circuit diagram illustrating the connection of a drain bias  
15           circuit pair to the drain bias load, drain bias kicker, and reference generator.

## DETAILED DESCRIPTION

A method and apparatus are described for providing a kicker function for a non-volatile memory drain bias.

In the following description, for the purposes of explanation, numerous specific details are set forth in order to provide a thorough understanding of the present invention. However, it will be apparent to one skilled in the art that the present invention may be practiced without some of these specific details. In other instances, well-known structures and devices are shown in block diagram form.

The present invention includes various steps, which will be described below. The steps of the present invention may be performed by hardware components or may be embodied in machine-executable instructions, which may be used to cause a general-purpose or special-purpose processor or logic circuits programmed with the instructions to perform the steps. Alternatively, the steps may be performed by a combination of hardware and software.

Figure 1 is a block diagram that illustrates the elements that are involved in sensing the contents of non-volatile memory under a particular embodiment.

Non-volatile memory device **100** includes a voltage reference **110**. Voltage reference **110** is connected to drain bias **120**, which maintains the necessary voltage levels for non-volatile memory cells. In this embodiment, the memory cells are included within memory **130**, which includes data array **140** and reference array **150**. From drain bias **120**, memory cell signals are transferred to pre-sense amplifier **160**, which provides data to post-sense amplifier latch **170**. Pre-sense amplifier **160** and post-sense amplifier latch

170 are included within sense amplifier 190. Data is transferred from post-sense latch 170 to memory device output 180.

### Static Reference Drain Bias

Previously, a drain bias circuit for flash memory typically was a feedback cascode drain bias utilizing an s' cascode device. (An s' device is a low threshold voltage n-channel device.) A conventional feedback cascode drain bias circuit is shown in Figure 2. In Figure 2, the gate of s' cascode device 200 is controlled by biasing feedback inverter 220. The feedback to the gate of s' cascode device 200 is controlled by the cell drain voltage from sense node or reference node, SEN/REN 230, if the drain reference is for the data array or the reference array, respectively. Connected to s' cascode device 200 is drain bias load 210. In this example, between drain bias load 210 and s' cascode device 200 is either the sense input node or the reference input node, SIN/RIN 240, depending on whether the drain bias circuit is connected to a data array cell or to a reference array cell. The other side of drain bias load 210 is connected to source voltage V<sub>CC</sub> 250.

In a particular embodiment, a drain bias circuit is as shown in Figure 3. This novel device is referred to as a static cascode drain bias. The voltage reference source connected to the gate of the cascode device is a static voltage reference that does not employ a feedback inverter. In this embodiment, an n-channel cascode device 300 is used, instead of an s' cascode device 200 as shown in Figure 2. The use of an n-channel device may reduce the capacitance related to the reference signal because an n-channel device may be physically smaller than an s' device. In Figure 3, the gate of n-channel cascode device 300 is connected to drain bias reference 320. In one embodiment, the

drain bias reference is the sample and hold reference generator shown in Figure 4 and described below. One terminal of n-channel cascode device **300** is connected to SEN/REN **330**, which is the path to the memory cell drain, and the other terminal is connected to load **310**. Between n-channel cascode device **300** and load **310** is either the sense input node or the reference input node, SIN/RIN **340**, depending on whether the drain bias circuit is connected to a data array cell or to a reference array cell. In one embodiment, load **310** is the drain bias column load and current mirror shown in Figure 5 and described below. The other side of the load is connected to  $V_{CC}$ , voltage source **350**. In one embodiment, sense input node or reference input node SIN/RIN **340** is also connected to the drain bias kicker circuit illustrated in Figure 6 and described below.

The embodiment shown in Figure 3 provides for a decrease in current and power consumption by the drain bias circuit. The embodiment does not require a feedback inverter and as a result the current drain associated with the drain bias function is reduced as compared with typical designs. As the number of cells of a non-volatile memory device that are read simultaneously in a single operation is increased, the power savings for the memory device become increasingly significant.

Further, the device utilizes an n-channel cascode device, thereby using a device with a higher Beta value. In this embodiment, it is possible to utilize an n-channel cascode device that is smaller than an s' cascode device, which reduces the physical area required on a memory device chip and reduces the resulting parasitic capacitance. The reduction in capacitance lowers the power requirements for the memory device. The n-channel device requires a higher gate voltage than is required for an s' device, and such gate voltage is supplied by the drain bias voltage reference. The embodiment shown in



Figure 3 has small sense node capacitance, which allows for high performance operation with low power consumption.

### Sample and Hold Reference Generator

For operation of the embodiment illustrated in Figure 3, a drain bias voltage reference may be included. The drain bias shown in Figure 2 typically would include a reference voltage for the feedback biasing, but this does not require a special voltage, as the voltage source  $V_{CC}$  may be used as the reference source for such a circuit. However, for the embodiment shown in Figure 3, a special drain bias circuit may be used to provide the necessary gate voltage.

Figure 4 illustrates a sample and hold reference generator under a particular embodiment. In the circuit, the output of differential amplifier **400** is connected to the gate of s' device **410**. The inputs to differential amplifier **400** are flash pair reference **405** and one terminal of s' device **410**. The flash pair reference **405** is a relatively stable voltage that differential amplifier **400** utilizes to regulate the source of s' device **410**.

Resistor ratio **415** is trimmable to provide the desired bit line voltage at node N1 **470**. Node N1 **470** then connects to the drain of cascode device **425**. Cascode device **425** is an n-channel device that is matched to the n-channel cascode device in the drain bias circuit to which the sample and hold reference generator is connected. In one embodiment in which the reference source in Figure 4 provides the voltage reference for the static reference drain bias circuit illustrated in Figure 3, cascode device **425** is matched to n-channel cascode device **300**. The source of cascode device **425** is connected to one terminal of p-channel device **430**. The gate of p-channel device **430** is connected to ground **435**. The second terminal of device **430** is connected to Y pump voltage **440**.

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(The voltage pump device is not shown.) In one embodiment, the voltage pump device raises the voltage above the level of the voltage source, which is useful when the source voltage for a non-volatile memory device is lowered to levels such as 1.8 volts. The reference voltage obtained from the gate of cascode device **425** is connected to one terminal of switching device **445**. The second terminal of switching device **445** is connected to capacitor **450**, which is then connected to ground **455**. Switching device **445** is a switch that is controlled by a pulse source and that periodically closes the connection between the gate of cascode device **425** and capacitor **450**. Upon closing switching device **445**, capacitor **450** is charged to the reference voltage. In one embodiment, the reference voltage is provided by capacitor **450** to a drain bias circuit via path **460**.

In a particular embodiment, the sample and hold reference generator shown in Figure 4 is the sole voltage reference for all read drain bias circuits in a non-volatile memory device. In a device in which a large number of memory cells are sensed simultaneously, the reference generator drives many transistors, and such transistors have a very large total capacitance. If the reference generator is powered up every time a read is executed, there is a large power cost. In this embodiment, the reference generator is powered up during the power up sequence for the memory device. Because of the sample and hold function, the reference circuit does not require power with every memory access, but rather only requires periodic refresh operation to charge capacitor **450** to the required reference voltage.

The reference generator consumes very little power because it is the sole reference source for the device and because power operation is only necessary

periodically. Instead, the circuit utilizes a large capacitance and from time to time charges up the capacitance by opening up the switch. In addition, the circuit provides  $V_t$  (threshold voltage) compensation across wide ranges of temperature and varying  $V_{CC}$  to make  $V_t$  largely independent of cascode characteristics.

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### Current Mirror and Column Load

In a certain embodiment, a circuit comprising a column load and a current mirror is used as a load for a non-volatile memory drain bias. In such a circuit, the column load acts as a resistance in the circuit, and is a standard device to reduce the area required for a resistance in a semiconductor device. The current mirror device provides a common  
10 mode current to the memory array. Sensing of flash memory is accomplished through voltage sensing, which is a sensing of the current multiplied times the resistance (the IR drop). The circuit samples or mirrors out part of the current. The common mode current is taken out of the reference and array side, and such action raises SIN/RIN levels and provides a bigger  $V_{ds}$  (the voltage between drain and source) to the cascode device. The  
15 higher voltage assists in keeping the cascode device in saturation at low  $V_{CC}$ .

However, a drain bias load that includes a current mirror can be a source of significant power loss because of the reference source. Figure 5 illustrates an embodiment in which the reference is a sample and hold reference source that results in significant power savings. The load illustrated in Figure 5 includes an s' column load  
20 device **500** with gate and one terminal of such device connected to voltage source  $V_{CC}$  **550**. The second terminal of s' column load device **500** is connected to either the sense input node or reference input node, SIN/RIN **530**, if the drain bias is for a memory cell in a data array or in a reference array, respectively. Such SIN/RIN node **530** is the input to

the sense amplifier and is connected to the drain of an n-channel cascode device. (The sense amplifier and the n-channel cascode device are not shown in Figure 5.)

In one embodiment, the n-channel cascode device connected at path **510** is device **300** shown in Figure 3 and the sense amplifier is sense amplifier **190** shown in Figure 1.

5 Also connected to RIN/SIN **530** is one terminal of current mirror device **520**. The second terminal of current mirror device **520** is attached to voltage source  $V_{CC}$  **550**, while the gate is connected to a path to sample and hold current mirror reference **540**. In a further embodiment, the sample and hold reference source is shown in Figure 4. As described above, a sample and hold reference source results in a significant power savings over  
10 typical voltage references. The drain bias load thus results in lower power operating for the drain bias circuit.

### Kicker for SIN/RIN Nodes

In one embodiment, a drain bias kicker circuit is connected to the SIN/RIN node of a drain bias circuit. A drain bias kicker circuit is shown in Figure 6. Such a kicker  
15 circuit is connected to the drain bias on both the data array and reference array sides. As illustrated in Figure 6, one terminal of high performance transistor **670** is connected to the SIN/RIN node **640**. According to one embodiment, high performance transistor **670** is a p-channel device. The second terminal of high performance transistor **670** is connected to voltage source  $V_{CC}$  **660**, while the gate of high performance transistor **670** is  
20 connected to kicker enable **650** through inverter **695**. The source of the kicker enable is not shown and may be a known pulse generating source. Also connected to SIN/RIN node **640** is n-channel cascode device **600** and drain bias load **610**.

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In this embodiment, kicker enable **650** activates p-channel device **670** through inverter **695** and provides a path from voltage source  $V_{CC}$  **660** to SIN/RIN node **640**. At the beginning of each memory access, the kicker pulse turns high performance transistor **670** on, thereby pulling SIN/RIN node **640** to the level of voltage source  $V_{CC}$  **660** and  
5 pulling the SEN/REN node to the level of the source voltage minus the voltage across the n-channel cascode device, or  $V_{CC} - V_{tcas}$ . When enabled, the kicker circuit acts as a temporary low resistance path to charge up the bit line. In one embodiment, kicker circuits pull both the SIN node and RIN node to  $V_{CC}$  before starting the sensing process, thereby equalizing the potential for the sense and reference sides. Bringing the sense and  
10 reference sides to the same potential then allows the differential voltage used for memory cell sensing to be developed more quickly, thus increasing operational speed.

In one embodiment, the SEN/REN node **630** is shorted to the matching sense or reference node for the corresponding data or reference drain bias circuit using s' device **680**. S' device **680** is activated by kicker enable **650**, and activating the device has the  
15 effect of equalizing the sense and reference nodes during bit line charging. This assists in accelerating sensing time when there is a mismatch between the capacitance of the main data array and the capacitance of the mini reference array in a memory device.

### Drain Bias Pair Circuit

Figure 7 illustrates one embodiment in which a drain bias circuit pair is shown  
20 together with embodiments of kicker circuits, current mirror and column loads, and sample and hold voltage references.

In one embodiment, the gates of current mirrors **700** and **705** are connected to sample and hold voltage reference **710**. The gates of column loads **715** and **720** are

connected to filtered voltage source  $V_{CC}$  725. The gates of high performance transistors 730 and 735 are connected to kicker enable 745 through inverter 740. N-channel cascode devices 750 and 755 are connected to sample and hold voltage reference 760. SEN node 770 and REN node 775 are equalized by s' device 765, which is enabled by kicker enable 745. The current mirrors, column loads, p-channel devices, and n-channel cascode devices for the data array and reference array sides are connected respectively to SIN node 780 and RIN node 785.